imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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THIS SPECIFICATION APPLIES TO THE ELECTROMAGNETIC BUZZER

SPECIFICATION

Test condition: TEMP=+25±2 ℃ Related humidity=65±5% Air pressure: 860 ~ 1060mbar

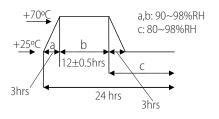
	/	1	
item	unit	specification	condition
rated voltage	Vo-p	12.0	
operating volt	Vo-р	9.0 ~ 15.0	
mean current	mA	Max. 30	At rated voltage direct current
sound output	dBA	83	At 10cm(A-weight free air), at rated voltage direct
			current
rated frequency	Hz	2300 ± 400	
operating temp	٥C	-20 ~ +60	
storage temp	٥C	-30 ~ +70	
dimension	mm	φ12.0×H7.5	See attached drawing
weight	gram	2.0	
material		PPO (Black)	
terminal		Pin type (Plating Sn)	See attached drawing
environmental		RoHS	
protection regulation			

ENVIRONMENT TEST

item	test condition	evaluation standard
 high temp. test	After being placed in a chamber at +70°C for 96 hours.	After the test the part will meet specifications without any degradation in appearance and performance except SPL, after 4 hours at +25°C. The SPL will be in ±10dBA compared with initial
low temp. test	After being placed in a chamber at -30°C for 96 hours.	
thermal shock	The part will be subjected to 10 cycles. One cycle shall consist of: 70°C -30°C -30°C -30 min 60 min	one.

temp./humidity cycle

The part will be subjected to 10 cycles. One cycle shall be 24 hours and consist of:





RELIABILITY TEST

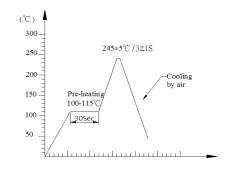
item	test conditions	evaluation standard
operating life test	ORDINARY TEMPERATURE	After the test the part will meet specifications
	The part will be subjected to 96 hours of	without any degradation in appearance and
	continuous operation at room temperature.	performance except SPL, after 4 hours at +25°C.
	HIGH TEMPERATURE	The SPL would be in ± 10 dBA compared with
	The part will be subjected to 72 hours of	initial one.
	continuous operation at +60°C with 12.0V	
	applied.	
	LOW TEMPERATURE	_
	The part will be subjected to 72 hours of	
	continuous operation at -20°C with 12.0V	
	applied.	
	HIGH AND LOW VOLTAGE	_
	Applying 9.0 voltage and 15.0 voltage, available	
	time 24 hours each.	
TEST CONDITION		

Standard Test Condition: a)Temperature: +5~+35°C b)Humidity:45~85% c)Pressure: 860~1060mbar

MECHANICAL CHARACTERISTICS

item	test conditions	evaluation standard
solderability	Lead terminal are immersed in rosin for 5 seconds and then immersed in solder bath of +250±5°C for 3±0.5 seconds.	90% min. lead terminals will be wet with solder No interference in operation.
soldering heat resistance	Lead terminal are immersed in soldering bath of $+250\pm5^{\circ}$ C for 2 ± 0.5 seconds.	-
 terminal mechanical strength	Apply the terminal with 1KG tension for 1 minute.	No damage and cutting off.
vibration	The part will be subjected to a vibration cycle of 10Hz to 55Hz to 10Hz in a period of 1 minute. Total peak amplitude will be 1.52mm(9.3G). The vibration test will consist of 2 hours per axis in each three axes(X,Y,Z). Total 6 hours.	After the test the part will meet specifications without any damage in appearance and performance except SPL. The SPL would be in ±10dBA compared with initial one.
drop test	The part only will be dropped from a height of 75cm onto a 40mm thick wooden board 3 times in 3 axes(X,Y,Z). Total of 9 times.	

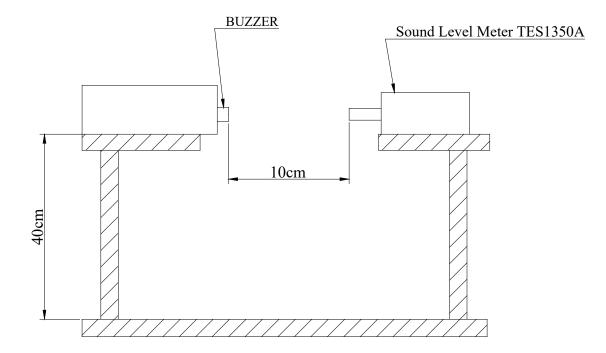
RECOMMENDED WAVE SOLDERING TEMPERATURE CURVE



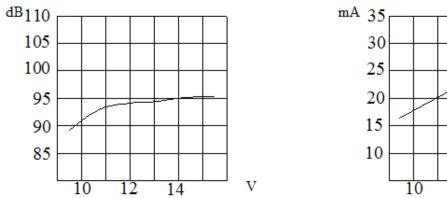


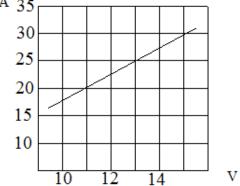
MODEL: WST-1212UX PRODUCT: Electromagnetic Buzzer EDITION: A/2016

INSPECTION FIXTURE



FREQUENCY RESPONSE





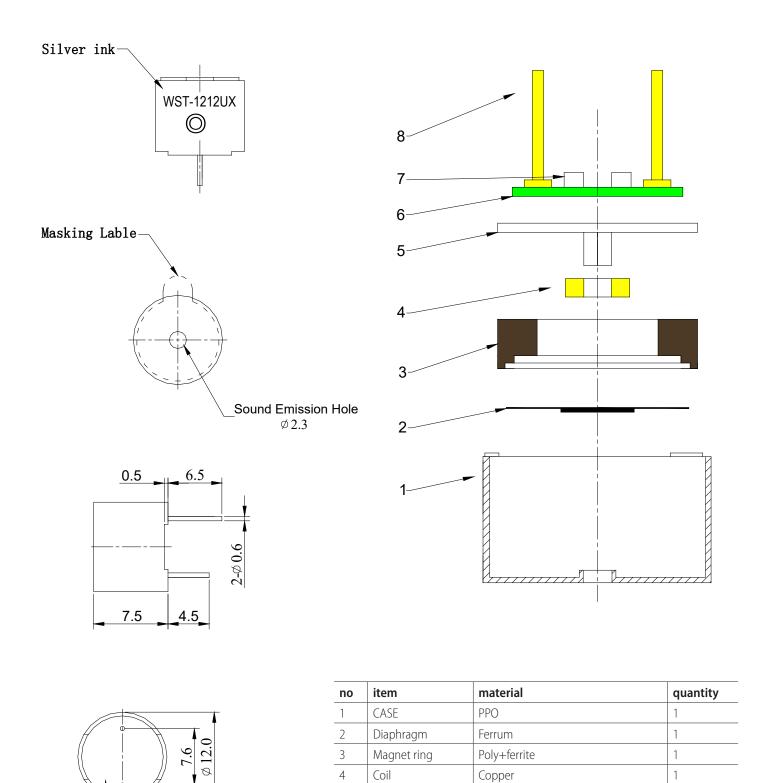


MODEL: WST-1212UX PRODUCT: Electromagnetic Buzzer EDITION: A/2016

DIMENSIONS

Tolerance:±0.5 (unit: mm)

Potting



5

6

7

8

Core

PCB

PIN

Transistor

Ferrum

Copper

Epoxy + copper

Epoxy glass fiber cloth + copper

1

1

2

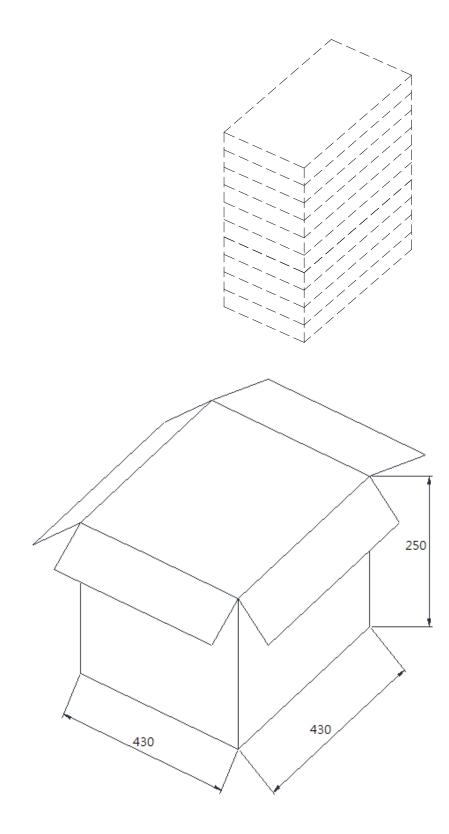
2



MODEL: WST-1212UX PRODUCT: Electromagnetic Buzzer EDITION: A/2016



PACKING



packing box LxWxH (mm)		pieces
Tray	190 x 190 x 25	100
Inner Cartons	210 x 210 x 220	1000
Outer Carton	430 x 430 x 250	4000